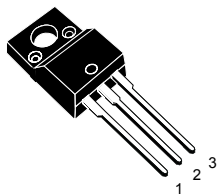
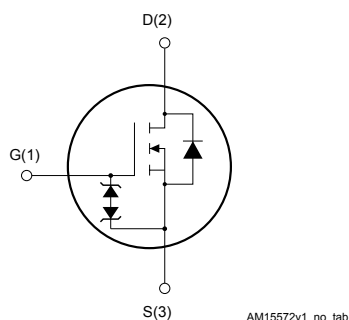


## N-channel 600 V, 105 mΩ typ., 25 A, MDmesh™ M6 Power MOSFET in a TO-220FP package



TO-220FP



### Features

| Order code | V <sub>DS</sub> | R <sub>DS(on)</sub> max. | I <sub>D</sub> |
|------------|-----------------|--------------------------|----------------|
| STF33N60M6 | 600 V           | 125 mΩ                   | 25 A           |

- Reduced switching losses
- Lower R<sub>DS(on)</sub> per area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

### Applications

- Switching applications
- LLC converters
- Boost PFC converters

### Description

The new MDmesh™ M6 technology incorporates the most recent advancements to the well-known and consolidated MDmesh family of SJ MOSFETs. STMicroelectronics builds on the previous generation of MDmesh devices through its new M6 technology, which combines excellent R<sub>DS(on)</sub> per area improvement with one of the most effective switching behaviors available, as well as a user-friendly experience for maximum end-application efficiency.

#### Product status link

[STF33N60M6](#)

#### Product summary

|            |            |
|------------|------------|
| Order code | STF33N60M6 |
| Marking    | 33N60M6    |
| Package    | TO-220FP   |
| Packing    | Tube       |

# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

| Symbol         | Parameter                                                                                                                               | Value      | Unit               |
|----------------|-----------------------------------------------------------------------------------------------------------------------------------------|------------|--------------------|
| $V_{GS}$       | Gate-source voltage                                                                                                                     | $\pm 25$   | V                  |
| $I_D^{(1)}$    | Drain current (continuous) at $T_{case} = 25\text{ }^{\circ}\text{C}$                                                                   | 25         | A                  |
|                | Drain current (continuous) at $T_{case} = 100\text{ }^{\circ}\text{C}$                                                                  | 15.8       |                    |
| $I_{DM}^{(2)}$ | Drain current (pulsed)                                                                                                                  | 78         | A                  |
| $P_{TOT}$      | Total dissipation at $T_{case} = 25\text{ }^{\circ}\text{C}$                                                                            | 35         | W                  |
| $dv/dt^{(3)}$  | Peak diode recovery voltage slope                                                                                                       | 15         | V/ns               |
| $dv/dt^{(4)}$  | MOSFET $dv/dt$ ruggedness                                                                                                               | 50         |                    |
| $V_{ISO}$      | Insulation withstand voltage (RMS) from all three leads to external heat sink ( $t = 1\text{ s}$ ; $T_C = 25\text{ }^{\circ}\text{C}$ ) | 2.5        | kV                 |
| $T_{stg}$      | Storage temperature range                                                                                                               | -55 to 150 | $^{\circ}\text{C}$ |
| $T_j$          | Operating junction temperature range                                                                                                    |            |                    |

- Limited by maximum junction temperature.
- Pulse width limited by safe operating area.
- $I_{SD} \leq 25\text{ A}$ ,  $di/dt \leq 400\text{ A}/\mu\text{s}$ ;  $V_{DS(peak)} < V_{(BR)DSS}$ ,  $V_{DD} = 400$ .
- $V_{DS} \leq 480\text{ V}$

**Table 2. Thermal data**

| Symbol         | Parameter                           | Value | Unit                        |
|----------------|-------------------------------------|-------|-----------------------------|
| $R_{thj-case}$ | Thermal resistance junction-case    | 3.6   | $^{\circ}\text{C}/\text{W}$ |
| $R_{thj-amb}$  | Thermal resistance junction-ambient | 62.5  | $^{\circ}\text{C}/\text{W}$ |

**Table 3. Avalanche characteristics**

| Symbol   | Parameter                                                                                                              | Value | Unit |
|----------|------------------------------------------------------------------------------------------------------------------------|-------|------|
| $I_{AR}$ | Avalanche current, repetitive or non-repetitive (pulse width limited by $T_{Jmax}$ )                                   | 4     | A    |
| $E_{AS}$ | Single pulse avalanche energy (starting $T_j = 25\text{ }^{\circ}\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50\text{ V}$ ) | 500   | mJ   |

## 2 Electrical characteristics

( $T_{\text{case}} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

**Table 4. On/off states**

| Symbol                      | Parameter                         | Test conditions                                                                                                          | Min. | Typ. | Max.    | Unit          |
|-----------------------------|-----------------------------------|--------------------------------------------------------------------------------------------------------------------------|------|------|---------|---------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage    | $V_{\text{GS}} = 0\text{ V}$ , $I_{\text{D}} = 1\text{ mA}$                                                              | 600  |      |         | V             |
| $I_{\text{DSS}}$            | Zero gate voltage drain current   | $V_{\text{GS}} = 0\text{ V}$ , $V_{\text{DS}} = 600\text{ V}$                                                            |      |      | 1       | $\mu\text{A}$ |
|                             |                                   | $V_{\text{GS}} = 0\text{ V}$ , $V_{\text{DS}} = 600\text{ V}$ ,<br>$T_{\text{case}} = 125\text{ }^{\circ}\text{C}^{(1)}$ |      |      | 100     |               |
| $I_{\text{GSS}}$            | Gate-body leakage current         | $V_{\text{DS}} = 0\text{ V}$ , $V_{\text{GS}} = \pm 25\text{ V}$                                                         |      |      | $\pm 5$ | $\mu\text{A}$ |
| $V_{\text{GS(th)}}$         | Gate threshold voltage            | $V_{\text{DS}} = V_{\text{GS}}$ , $I_{\text{D}} = 250\text{ }\mu\text{A}$                                                | 3.25 | 4    | 4.75    | V             |
| $R_{\text{DS(on)}}$         | Static drain-source on-resistance | $V_{\text{GS}} = 10\text{ V}$ , $I_{\text{D}} = 12.5\text{ A}$                                                           |      | 105  | 125     | m $\Omega$    |

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

| Symbol                     | Parameter                     | Test conditions                                                                                                                                                        | Min. | Typ. | Max. | Unit     |
|----------------------------|-------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|----------|
| $C_{\text{iss}}$           | Input capacitance             | $V_{\text{DS}} = 100\text{ V}$ , $f = 1\text{ MHz}$ , $V_{\text{GS}} = 0\text{ V}$                                                                                     | -    | 1515 | -    | pF       |
| $C_{\text{oss}}$           | Output capacitance            |                                                                                                                                                                        | -    | 128  | -    |          |
| $C_{\text{rss}}$           | Reverse transfer capacitance  |                                                                                                                                                                        | -    | 4.2  | -    |          |
| $C_{\text{oss eq.}}^{(1)}$ | Equivalent output capacitance | $V_{\text{DS}} = 0\text{ to }480\text{ V}$ , $V_{\text{GS}} = 0\text{ V}$                                                                                              | -    | 269  | -    | pF       |
| $R_{\text{G}}$             | Intrinsic gate resistance     | $f = 1\text{ MHz}$ , $I_{\text{D}} = 0\text{ A}$                                                                                                                       | -    | 1.5  | -    | $\Omega$ |
| $Q_{\text{g}}$             | Total gate charge             | $V_{\text{DD}} = 480\text{ V}$ , $I_{\text{D}} = 25\text{ A}$ ,<br>$V_{\text{GS}} = 0\text{ to }10\text{ V}$<br>(see Figure 14. Test circuit for gate charge behavior) | -    | 33.4 | -    | nC       |
| $Q_{\text{gs}}$            | Gate-source charge            |                                                                                                                                                                        | -    | 7.2  | -    |          |
| $Q_{\text{gd}}$            | Gate-drain charge             |                                                                                                                                                                        | -    | 16.3 | -    |          |

1.  $C_{\text{oss eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{\text{oss}}$  when  $V_{\text{DS}}$  increases from 0 to 80%  $V_{\text{DSS}}$ .

**Table 6. Switching times**

| Symbol              | Parameter           | Test conditions                                                                                                                                                                                                                                    | Min. | Typ. | Max. | Unit |
|---------------------|---------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $t_{\text{d(on)}}$  | Turn-on delay time  | $V_{\text{DD}} = 300\text{ V}$ , $I_{\text{D}} = 12.5\text{ A}$ ,<br>$R_{\text{G}} = 4.7\text{ }\Omega$ , $V_{\text{GS}} = 10\text{ V}$<br>(see Figure 13. Test circuit for resistive load switching times and Figure 18. Switching time waveform) | -    | 19.5 | -    | ns   |
| $t_{\text{r}}$      | Rise time           |                                                                                                                                                                                                                                                    | -    | 33   | -    |      |
| $t_{\text{d(off)}}$ | Turn-off delay time |                                                                                                                                                                                                                                                    | -    | 38.5 | -    |      |
| $t_{\text{f}}$      | Fall time           |                                                                                                                                                                                                                                                    | -    | 7.5  | -    |      |

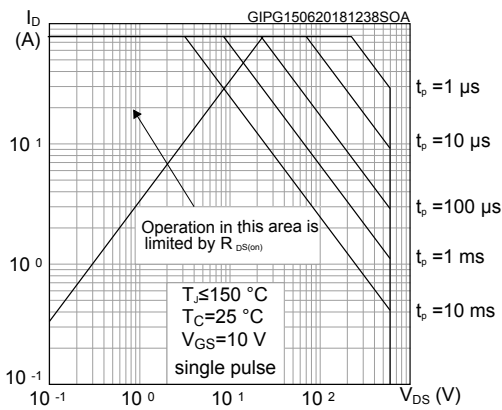
**Table 7. Source-drain diode**

| Symbol          | Parameter                     | Test conditions                                                                                                                                                                                                    | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|---------------|
| $I_{SD}$        | Source-drain current          |                                                                                                                                                                                                                    | -    |      | 25   | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |                                                                                                                                                                                                                    | -    |      | 78   | A             |
| $V_{SD}^{(2)}$  | Forward on voltage            | $I_{SD} = 25\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                                                                                                                     | -    |      | 1.6  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 25\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 60\text{ V}$<br>(see Figure 15. Test circuit for inductive load switching and diode recovery times)                                     | -    | 265  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                                                                    | -    | 3.07 |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                                                                    | -    | 23.2 |      | A             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 25\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 60\text{ V}$ , $T_j = 150\text{ }^\circ\text{C}$<br>(see Figure 15. Test circuit for inductive load switching and diode recovery times) | -    | 374  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                                                                    | -    | 5.78 |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                                                                    | -    | 30.9 |      | A             |

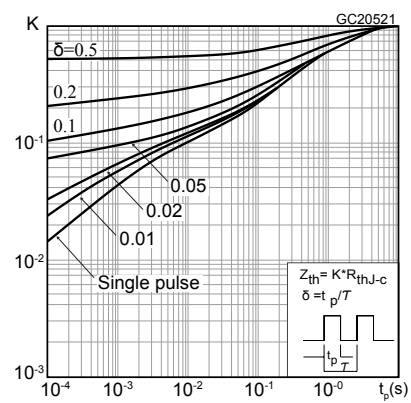
1. Pulse width is limited by safe operating area.
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

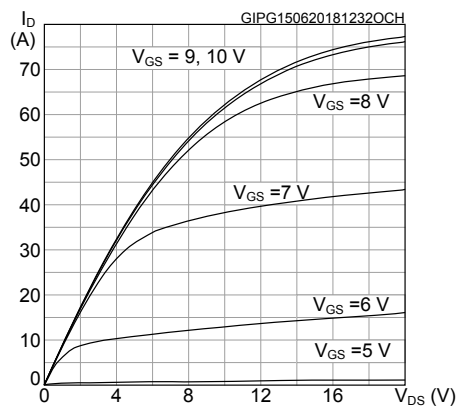
**Figure 1. Safe operating area**



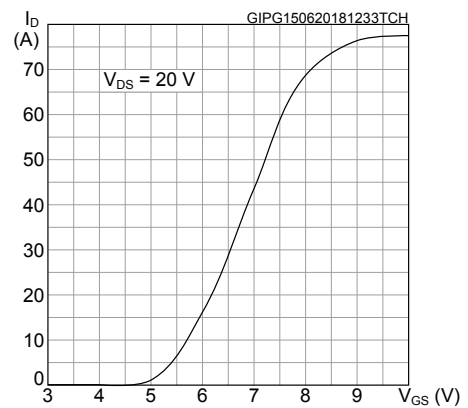
**Figure 2. Thermal impedance**



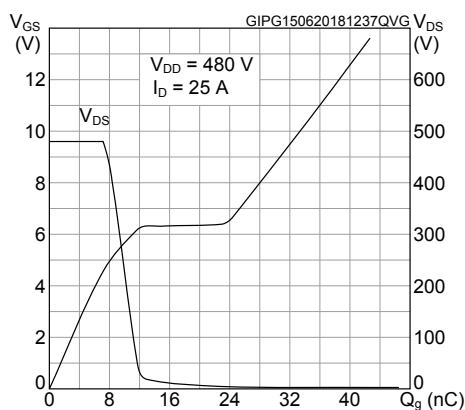
**Figure 3. Output characteristics**



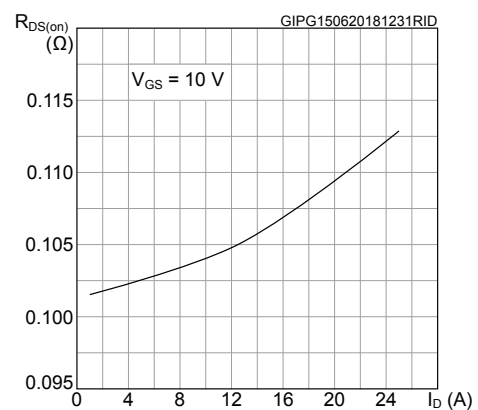
**Figure 4. Transfer characteristics**

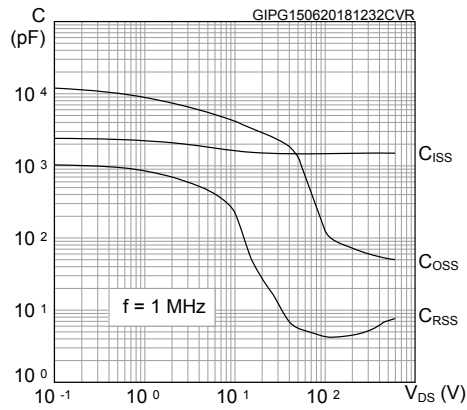
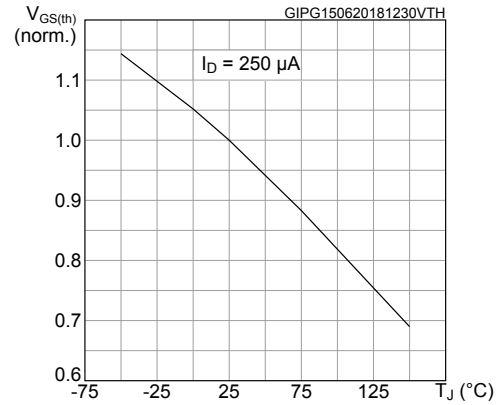
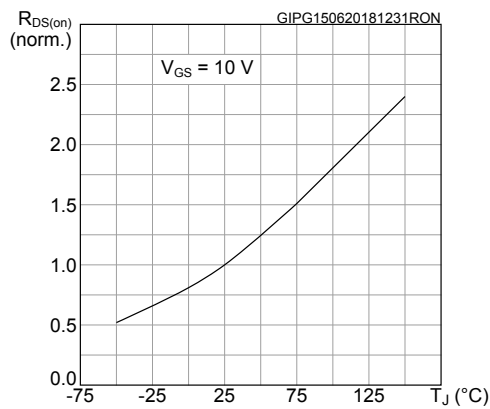
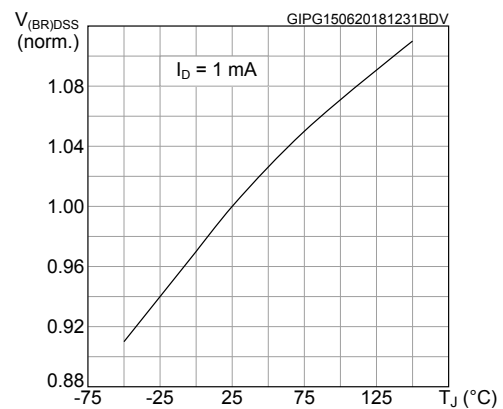
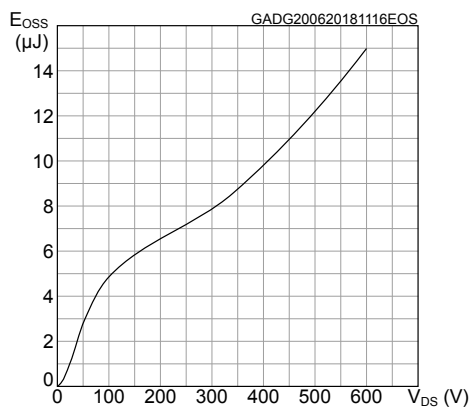
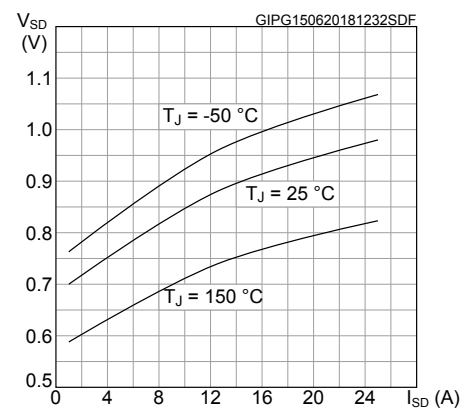


**Figure 5. Gate charge vs gate-source voltage**

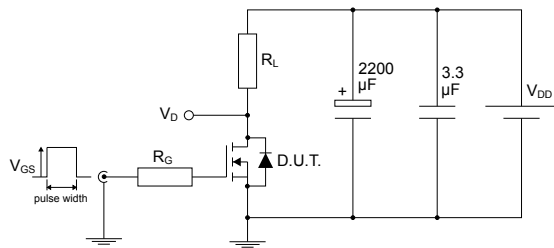


**Figure 6. Static drain-source on-resistance**

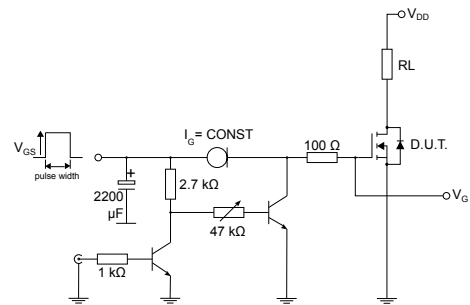


**Figure 7. Capacitance variations**

**Figure 8. Normalized gate threshold voltage vs temperature**

**Figure 9. Normalized on-resistance vs temperature**

**Figure 10. Normalized  $V_{(BR)DSS}$  vs temperature**

**Figure 11. Output capacitance stored energy**

**Figure 12. Source-drain diode forward characteristics**


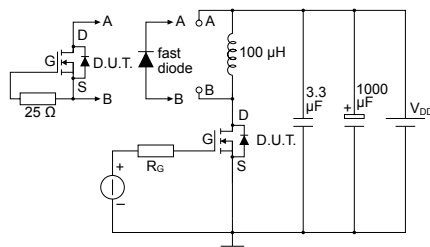
### 3 Test circuits

**Figure 13. Test circuit for resistive load switching times**


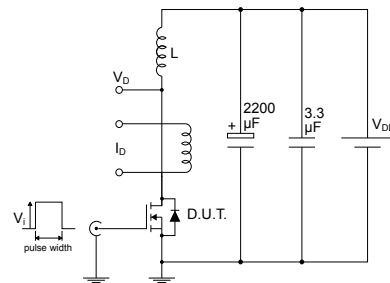
AM01468v1

**Figure 14. Test circuit for gate charge behavior**


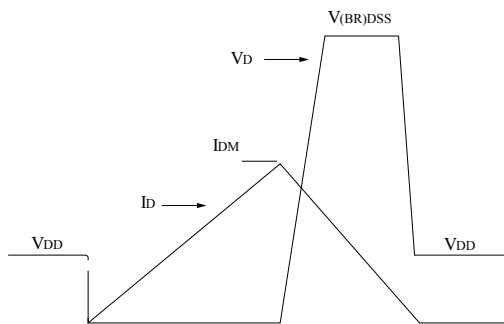
AM01469v10

**Figure 15. Test circuit for inductive load switching and diode recovery times**


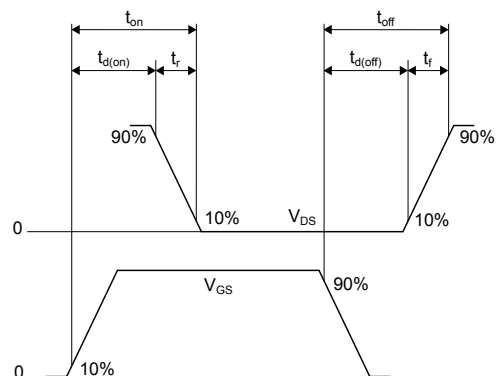
AM01470v1

**Figure 16. Unclamped inductive load test circuit**


AM01471v1

**Figure 17. Unclamped inductive waveform**


AM01472v1

**Figure 18. Switching time waveform**


AM01473v1

## **4 Package information**

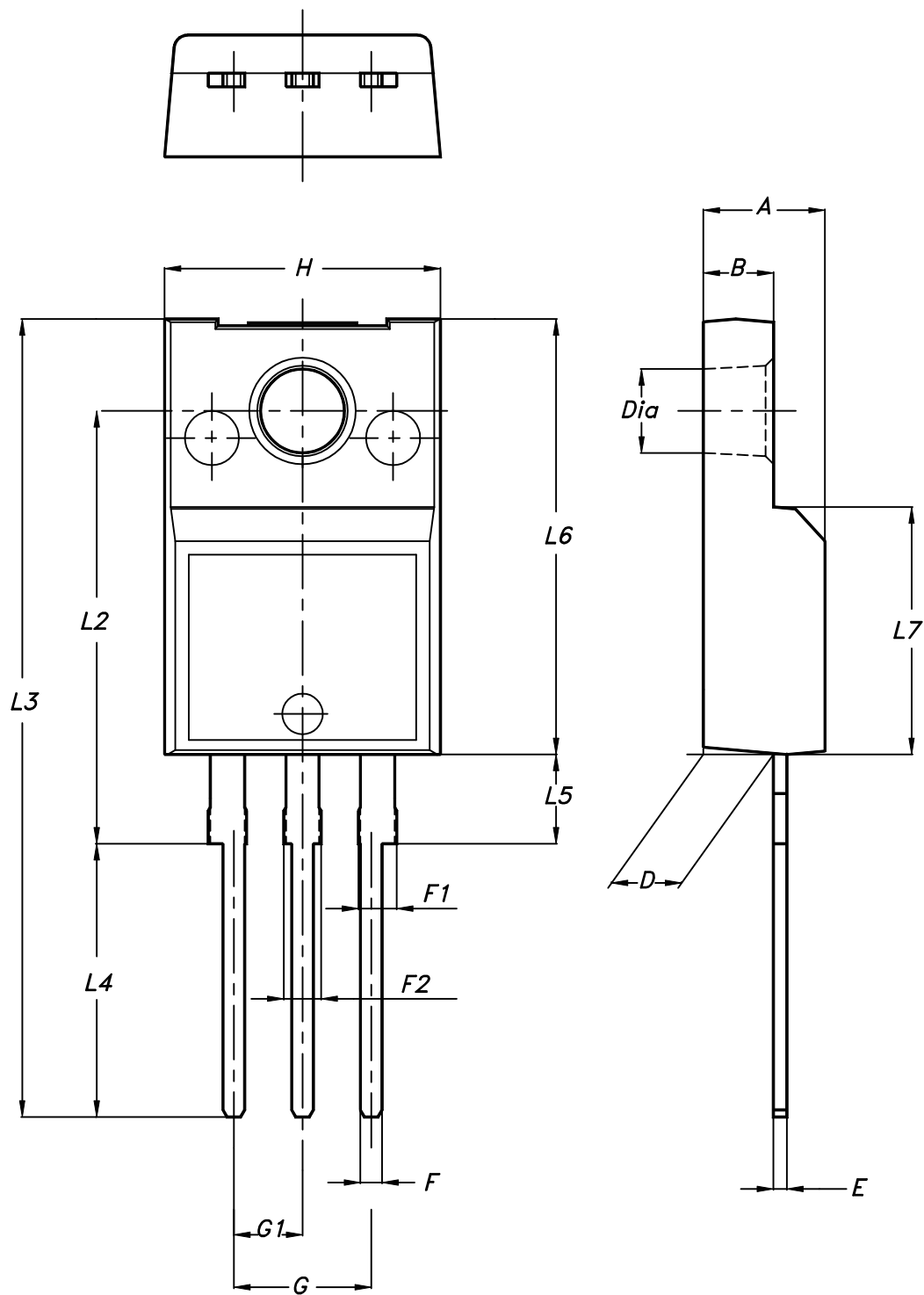
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## 4.1 TO-220FP package information

Figure 19. TO-220FP package outline



7012510\_Rev\_12\_B

**Table 8. TO-220FP package mechanical data**

| Dim. | mm   |      |      |
|------|------|------|------|
|      | Min. | Typ. | Max. |
| A    | 4.4  |      | 4.6  |
| B    | 2.5  |      | 2.7  |
| D    | 2.5  |      | 2.75 |
| E    | 0.45 |      | 0.7  |
| F    | 0.75 |      | 1    |
| F1   | 1.15 |      | 1.70 |
| F2   | 1.15 |      | 1.70 |
| G    | 4.95 |      | 5.2  |
| G1   | 2.4  |      | 2.7  |
| H    | 10   |      | 10.4 |
| L2   |      | 16   |      |
| L3   | 28.6 |      | 30.6 |
| L4   | 9.8  |      | 10.6 |
| L5   | 2.9  |      | 3.6  |
| L6   | 15.9 |      | 16.4 |
| L7   | 9    |      | 9.3  |
| Dia  | 3    |      | 3.2  |

## Revision history

**Table 9. Document revision history**

| Date        | Version | Changes                                                                                                              |
|-------------|---------|----------------------------------------------------------------------------------------------------------------------|
| 02-Jul-2018 | 1       | Initial release.                                                                                                     |
| 18-Jul-2018 | 2       | The document status is production data.<br>Modified <a href="#">Section 3 Test circuits</a> .<br>Minor text changes. |

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